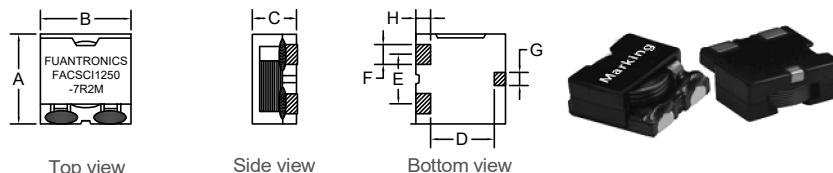


P/N: FACSCI1250-7R2M

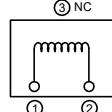


Outline Dimensions(Unit:mm)

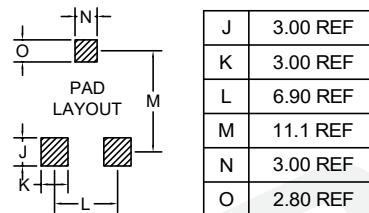


A	B	C	D	E	F	G	H
Max	± 0.40	± 0.30	REF	REF		REF	REF
13.5	12.5	5.00	9.00	6.90	2.0-2.6	2.60	2.00

Electronical Schematic



Suggested Pad layout



***Magnetic shielded structure: excellent resistance to electro magnetic interference(EMI)

***Assemblage design, sturdy structure

***Small volume, high current, low magnetic loss, low ESR, small parasitic capacitance

***Small volume, high current, low magnetic loss, low ESR, small parasitic capacitance, ***Temperature rise current and saturation current is less influenced by environment.

Electrical Characteristics(@25°C)

Inductance 100KHz,0.1V	DC Resistor	Saturated current 6A	Temperature rise current 7.5A
7.20uH±20%	14.0mΩ Max	L(6A)=80%*L0A Typ	T≤40°C Typ

***Saturation current: the actual value of DC current when the inductance decreases 20% of its initial value.

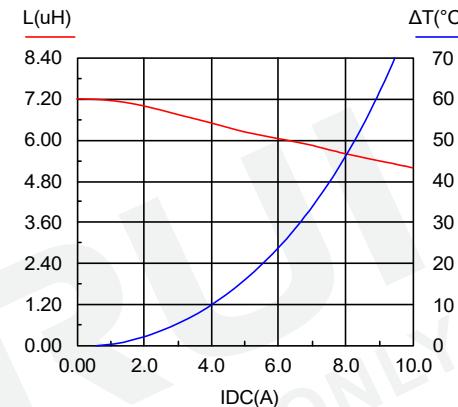
****Temperature rise current: the actual value of DC current when the temperature rise is AT40°C(Ta=25°C)

***Operating Temperature: -40°C~+125°C.
(Temperature rise included)

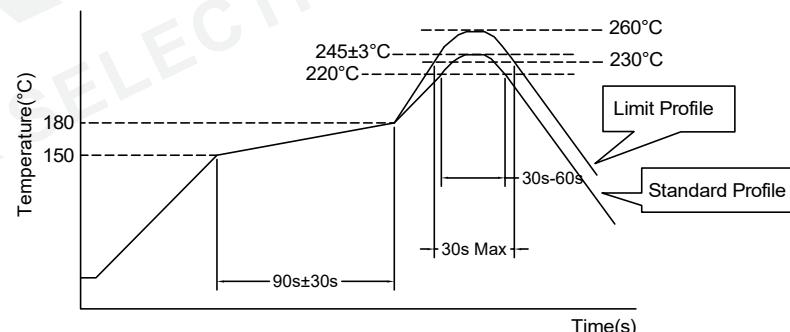
***Storage Temperature: -40°C~+125°C

***Storage Humidity: RH10%~70%

Saturation current VS temperature rise current curve:



Recommended Soldering Temperature Graph.



	Standard Profile	Standard Profile
Pre-heating	150~180°C,90s±30s	
Heating	above 220°C,30s-60s	above 240°C,30s Max
Peak temperature	245°C±3°C	260°C,10s
Cycle of reflow	2 times	2 times

				Tianchang Fuan Electronic Co Ltd www.fuantronics.net TEL: +86-550-7814888 FAX:+86-550-7831133	 Tolerances unless otherwise specified: $(X)\pm 0.50$ $(XX)\pm 0.25$ Unit of measurement: mm	Make: Qiumei.Liu	DRAWING TITLE HIGH CURRENT POWER INDUCTORS	Customer Name:
						Checked: Beson. zhan		Document/Rev: 00
REV	DESCRIPTION	APPD	DATE			Approved: Anson. zhan		Specification Sheet: 1 of 1
							Material Number: A341250XS200	Date of Recognition: Jan./02/2020